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$V_Z(\text{max.}) = 19.1 \text{ V} / 28.9 \text{ V} / 35 \text{ V} / 42.2 \text{ V}$   
**Transient Voltage Suppressor**  
**SJPZ-N Series**

**Description**

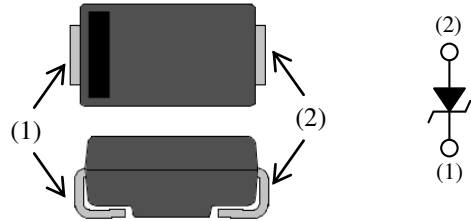
Sanken SJPZ-N series devices are power zener diodes designed for the protection of automotive electronic units from especially the surge generated during load dump conditions, voltage transients induced by inductive loads.

**Features**

- AEC-Q101 Qualified
- Meets ISO7637-2 Surge Protection Specification (Pulse 1-3)
- High Reliability and Automotive Requirement
- High Surge Capability
- Flammability UL94V-0 (Equivalent)
- Compliant with RoHS Directive

**Package**

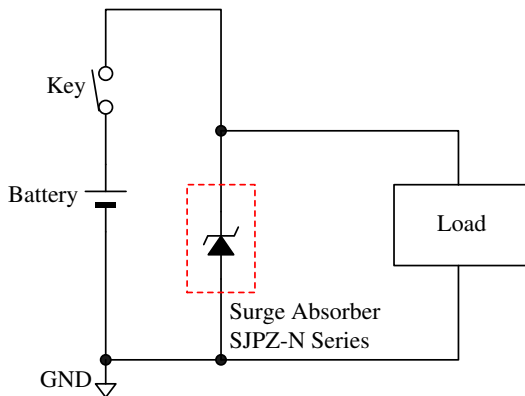
SJP



(1) Cathode  
 (2) Anode

Not to Scale

**Typical Application**



**SJPZ-N Series**

| Products | $V_Z$ |       | $P_{RSM}^*$ | $P_D$ |
|----------|-------|-------|-------------|-------|
|          | Min.  | Max.  |             |       |
| SJPZ-N18 | 16.8V | 19.1V | 500W        | 2 W   |
| SJPZ-N27 | 25.1V | 28.9V |             |       |
| SJPZ-N33 | 31.0V | 35.0V |             |       |
| SJPZ-N40 | 37.8V | 42.2V |             |       |

\*500  $\mu$ s, single block pulse

**Application**

Protection of sensitive electronic equipment in passenger cars, trucks, vans and buses:

- Engine Control Units
- Electric Control Units
- Braking System
- Power Steering System
- Airbags
- Audio & Infotainment Equipment

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## SJPZ-N Series

### 1. Absolute Maximum Ratings

Unless specifically noted  $T_A = 25\text{ }^\circ\text{C}$ .

| Parameter                        | Symbol    | Conditions                             | Rating     | Unit             | Note     |
|----------------------------------|-----------|--|------------|------------------|----------|
| Power Dissipation <sup>(1)</sup> | $P_D$     | Lead temperature, $T_L$ <sup>(2)</sup> | 2          | W                |          |
| DC Blocking Voltage              | $V_{DC}$  | -                                      | 13         | V                | SJPZ-N18 |
|                                  |           |  | 20         |                  | SJPZ-N27 |
|                                  |           |  | 25         |                  | SJPZ-N33 |
|                                  |           |  | 30         |                  | SJPZ-N40 |
| Peak Reverse Power               | $P_{RSM}$ | 500 $\mu\text{s}$ , single block pulse | 500        | W                |          |
| Junction Temperature             | $T_j$     | -                                      | -55 to 150 | $^\circ\text{C}$ |          |
| Storage Temperature              | $T_{stg}$ | -                                      | -55 to 150 | $^\circ\text{C}$ |          |

<sup>(1)</sup> See Figure 3-1, Power Dissipation Curve

<sup>(2)</sup> See Figure 1-1

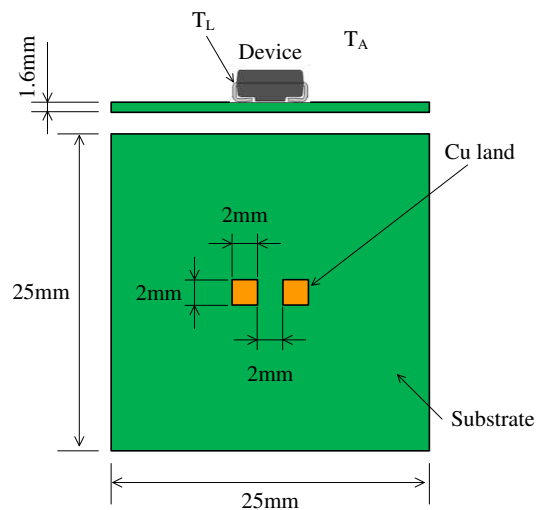


Figure 1-1 Lead temperature measurement condition

## SJPZ-N Series

### 2. Electrical Characteristics

Unless specifically noted,  $T_A = 25\text{ }^\circ\text{C}$ .

| Parameter                                 | Symbol               | Conditions                             | Min. | Typ. | Max. | Unit                       | Note     |
|---|----------------------|--|------|------|------|----------------------------|----------|
| Forward Voltage Drop                      | $V_F$                | $I_F = 2\text{ A}$                     | –    | –    | 1.20 | V                          |          |
| Reverse Leakage Current                   | $I_R$                | $V_R = 13\text{ V}$                    | –    | –    | 1    | $\mu\text{A}$              | SJPZ-N18 |
|   |                      | $V_R = 20\text{ V}$                    |      |      |      |                            | SJPZ-N27 |
|   |                      | $V_R = 25\text{ V}$                    |      |      |      |                            | SJPZ-N33 |
|   |                      | $V_R = 30\text{ V}$                    |      |      |      |                            | SJPZ-N40 |
| Breakdown Voltage                         | $V_Z$                | $I_Z = 1\text{ mA}$                    | 16.8 | –    | 19.1 | V                          | SJPZ-N18 |
|   |                      |  | 25.1 | –    | 28.9 |                            | SJPZ-N27 |
|   |                      |  | 31.0 | –    | 35.0 |                            | SJPZ-N33 |
|   |                      |  | 37.8 | –    | 42.2 |                            | SJPZ-N40 |
| Breakdown Voltage Temperature Coefficient | $r_Z$                | $I_Z = 1\text{ mA}$                    | –    | 13   | –    | $\text{mV}/^\circ\text{C}$ | SJPZ-N18 |
|   |                      |  | –    | 23   | –    |                            | SJPZ-N27 |
|   |                      |  | –    | 29   | –    |                            | SJPZ-N33 |
|   |                      |  | –    | 35   | –    |                            | SJPZ-N40 |
| Breakdown Region Equivalent Resistance    | $R_Z$                | $I_Z = 10\text{ mA} \sim 20\text{ mA}$ | –    | 2    | –    | $\Omega$                   | SJPZ-N18 |
|   |                      |  | –    | 4    | –    |                            | SJPZ-N27 |
|   |                      |  | –    | 5    | –    |                            | SJPZ-N33 |
|   |                      |  | –    | 7    | –    |                            | SJPZ-N40 |
| Thermal Resistance                        | $R_{\text{th}(j-L)}$ | (*)                                    | –    | 20   | –    | $^\circ\text{C}/\text{W}$  |          |

(\*)  $R_{\text{th}(j-L)}$  is thermal resistance between junction and lead. Lead temperature is measured as shown in Figure 1-1.

3. Performance Curves

3.1. Power Dissipation

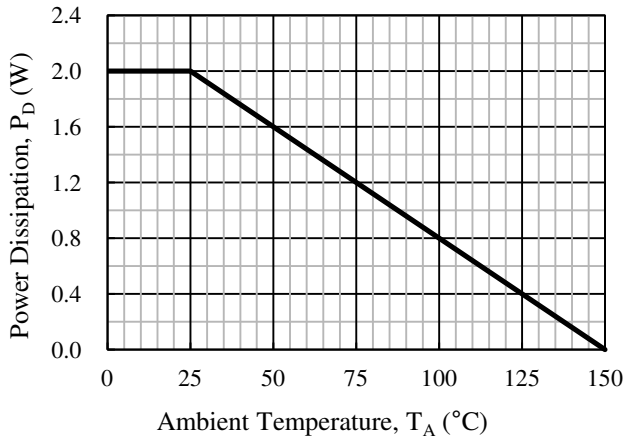


Figure 3-1 Power Dissipation curve\*

\* The mounting condition of the IC is shown in Figure 1-1.

3.2. Peak Surge Reverse Power Capability

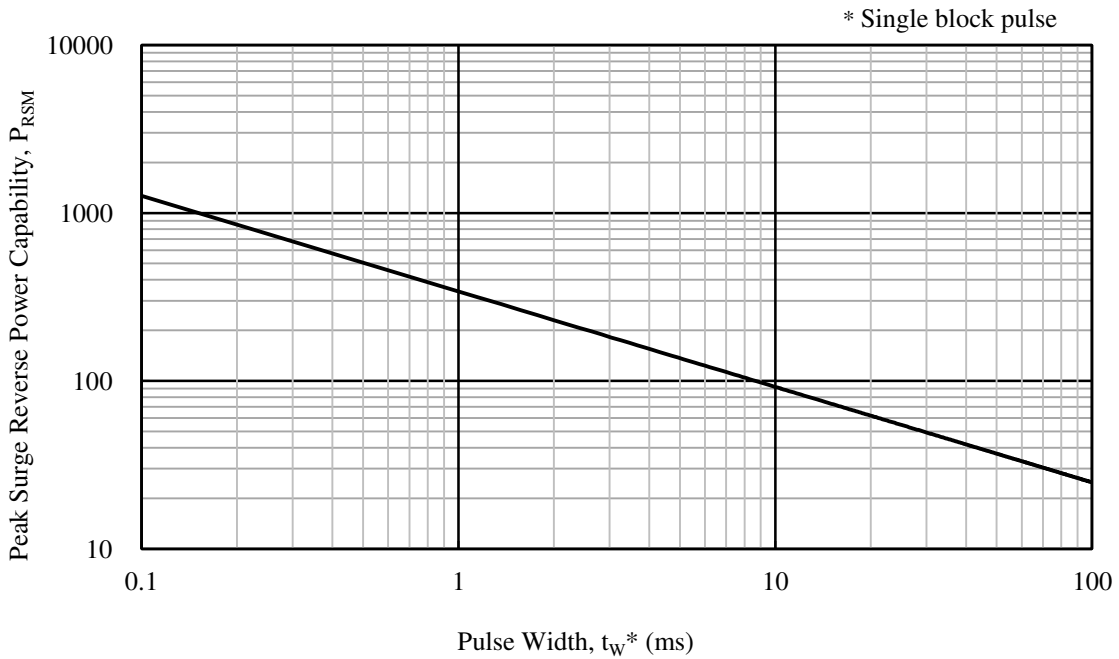


Figure 3-2 Peak surge reverse power capability

3.3. SJPZ-N18 Typical Characteristics

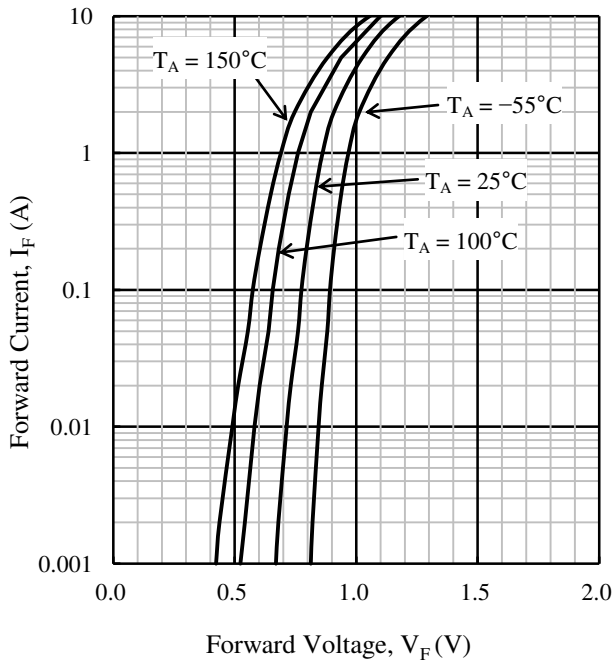


Figure 3-3  $I_F - V_F$  typical characteristics

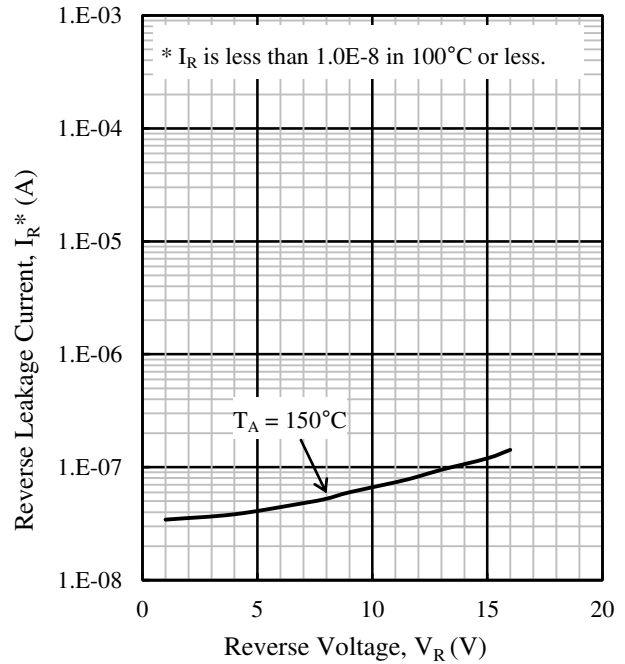


Figure 3-4  $I_R - V_R$  typical characteristics

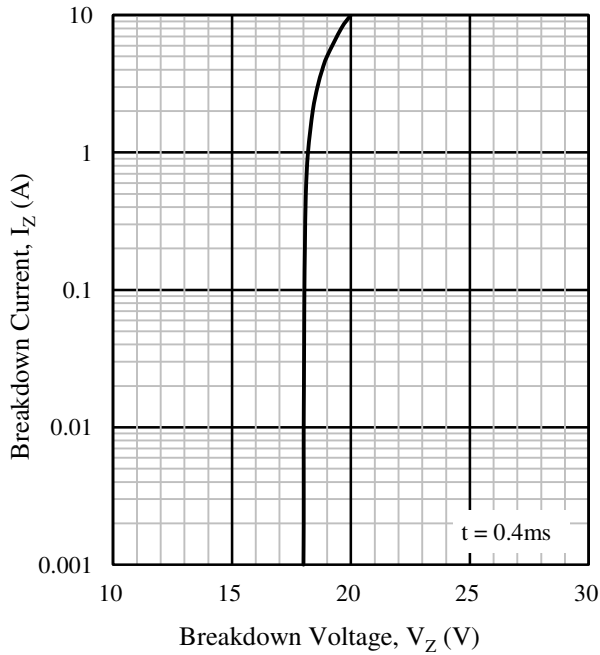


Figure 3-5  $I_Z - V_Z$  typical characteristics

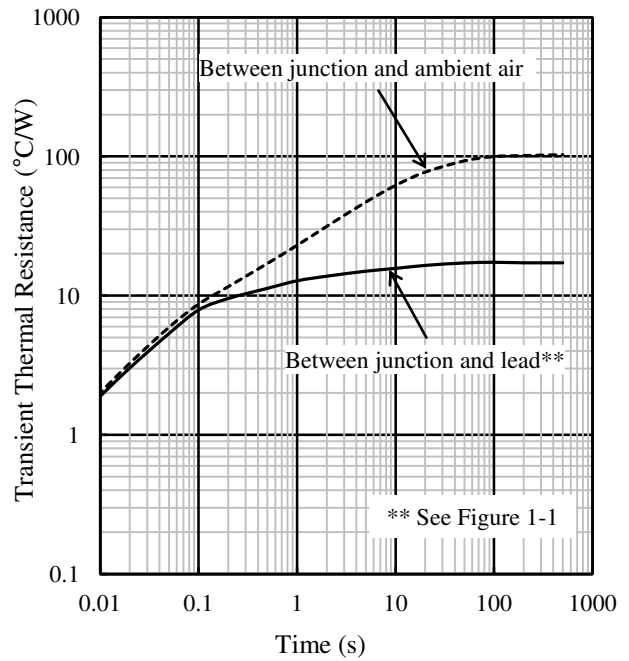


Figure 3-6 Typical transient thermal resistance

3.4. SJPZ-N27 Typical Characteristics

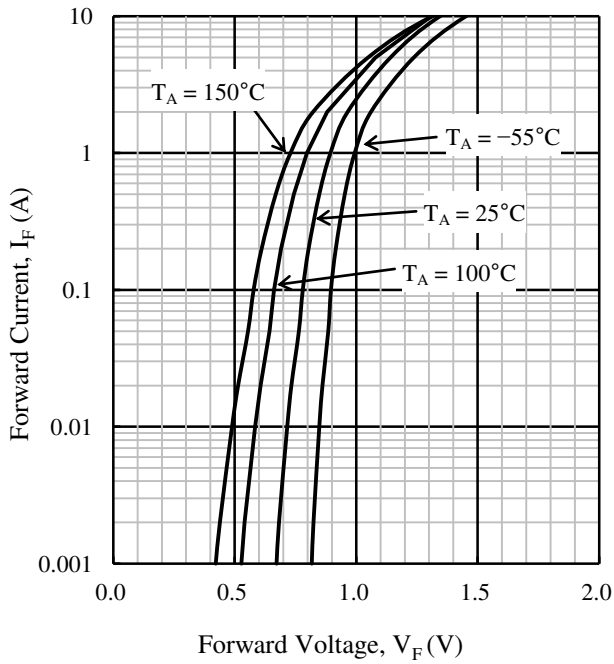


Figure 3-7  $I_F - V_F$  typical characteristics

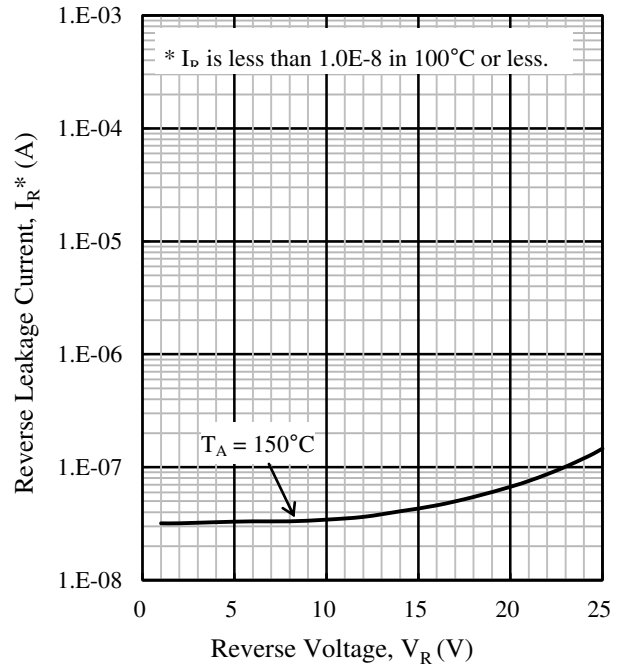


Figure 3-8  $I_R - V_R$  typical characteristics

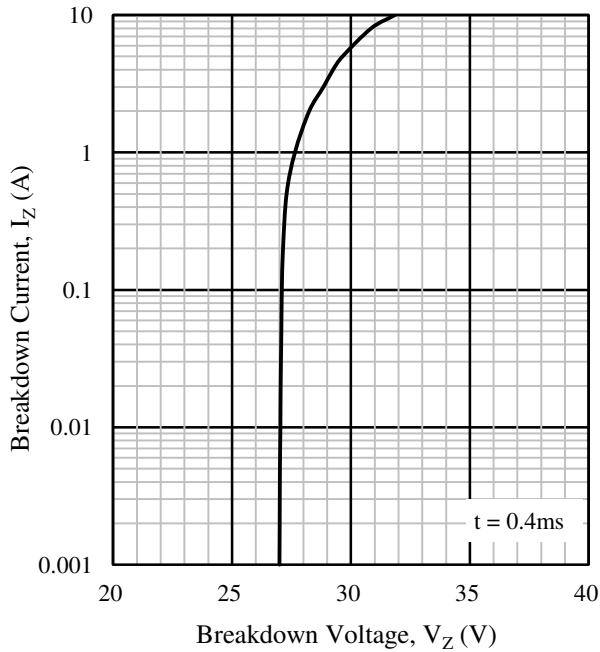


Figure 3-9  $I_Z - V_Z$  typical characteristics

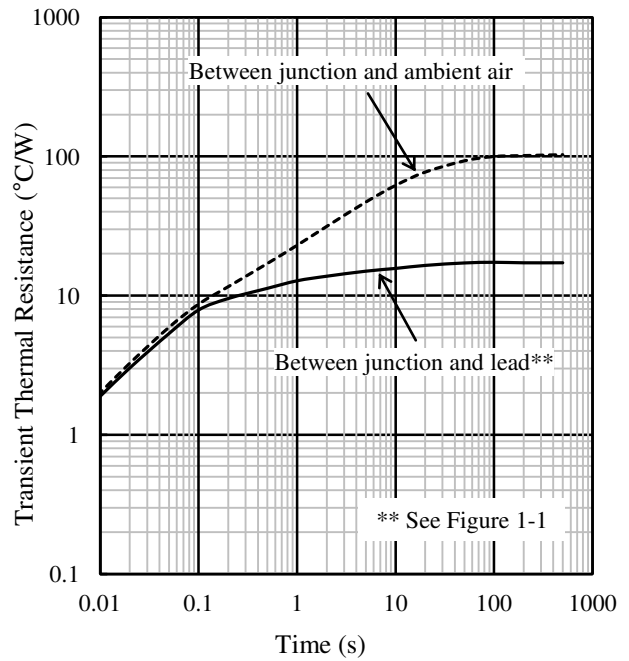


Figure 3-10 Typical transient thermal resistance



3.5. SJPZ-N33 Typical Characteristics

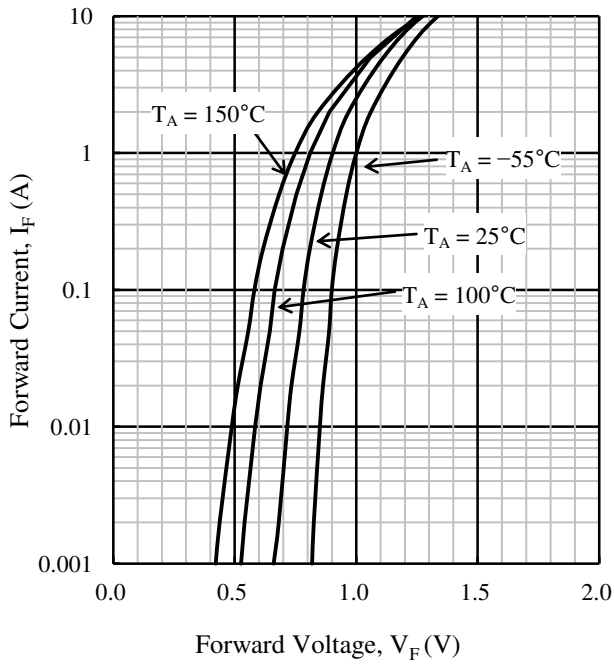


Figure 3-11  $I_F - V_F$  typical characteristics

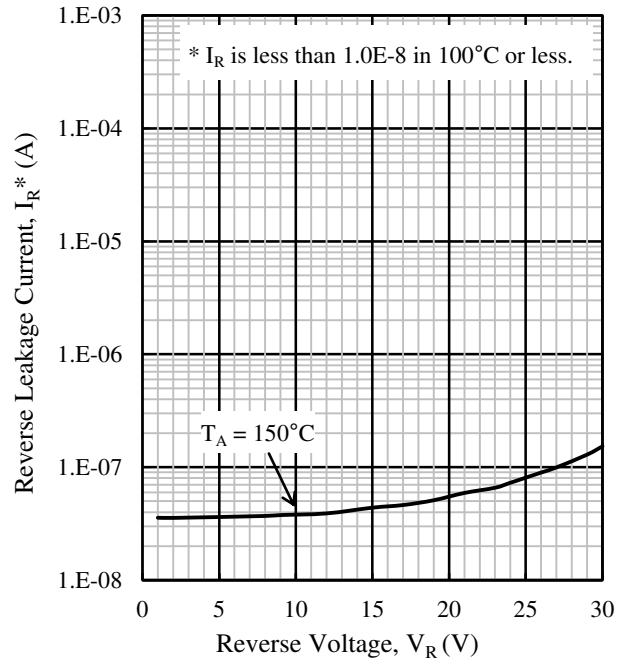


Figure 3-12  $I_R - V_R$  typical characteristics

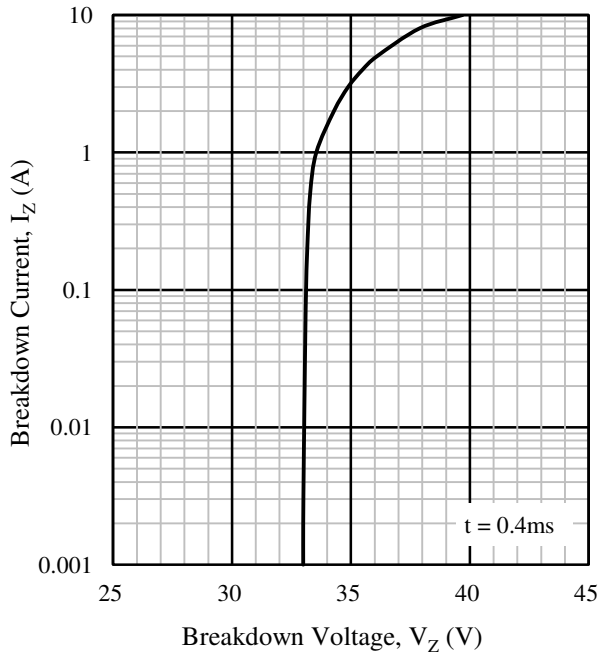


Figure 3-13  $I_Z - V_Z$  typical characteristics

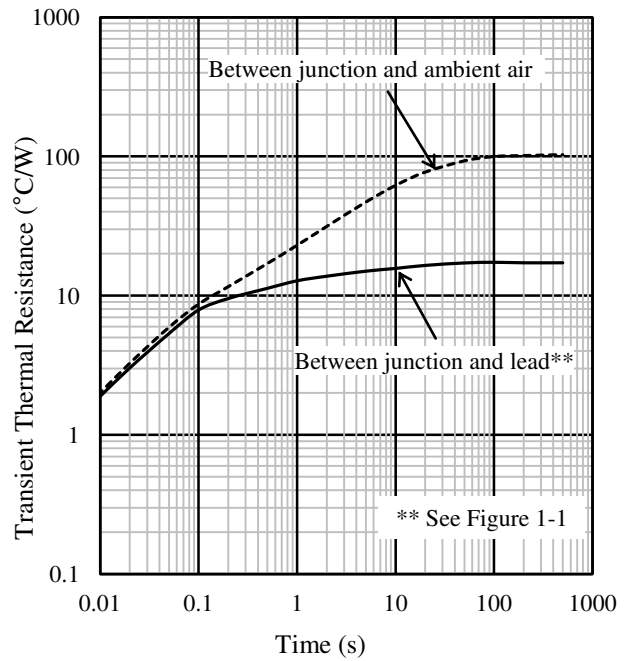


Figure 3-14 Typical transient thermal resistance

3.6. SJPZ-N40 Typical Characteristics

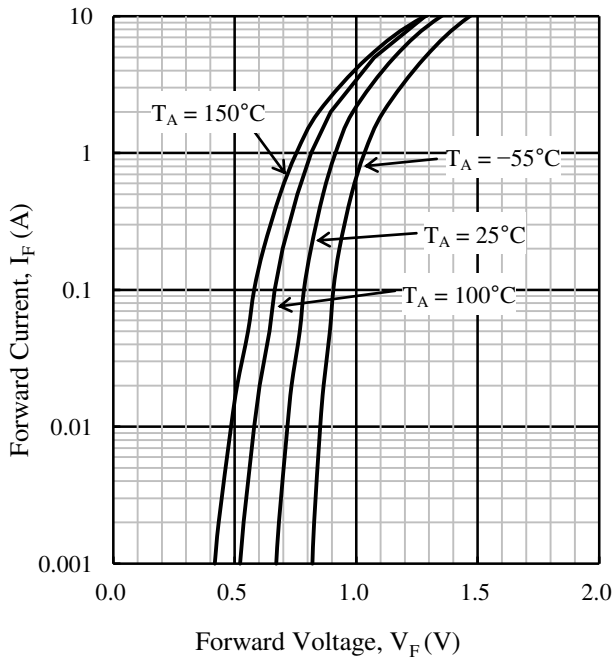


Figure 3-15  $I_F - V_F$  typical characteristics

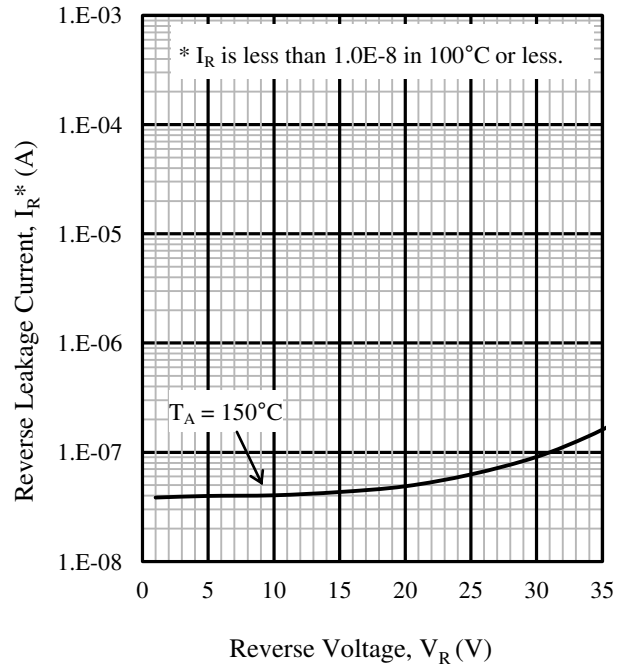


Figure 3-16  $I_R - V_R$  typical characteristics

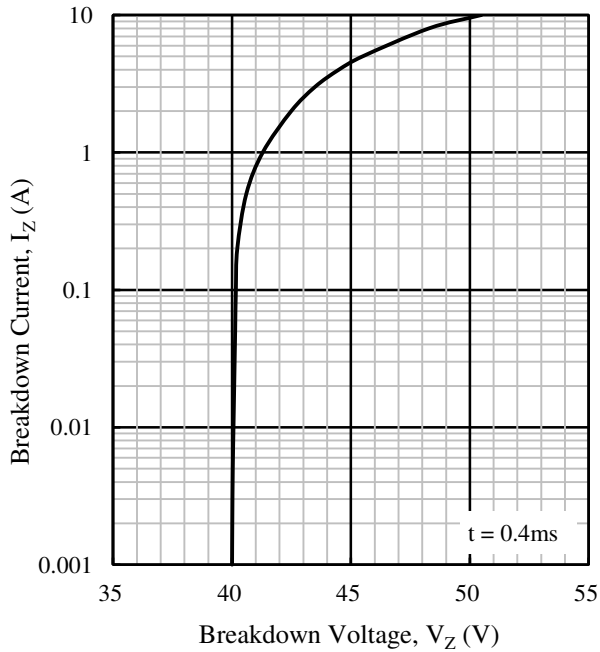


Figure 3-17  $I_Z - V_Z$  typical characteristics

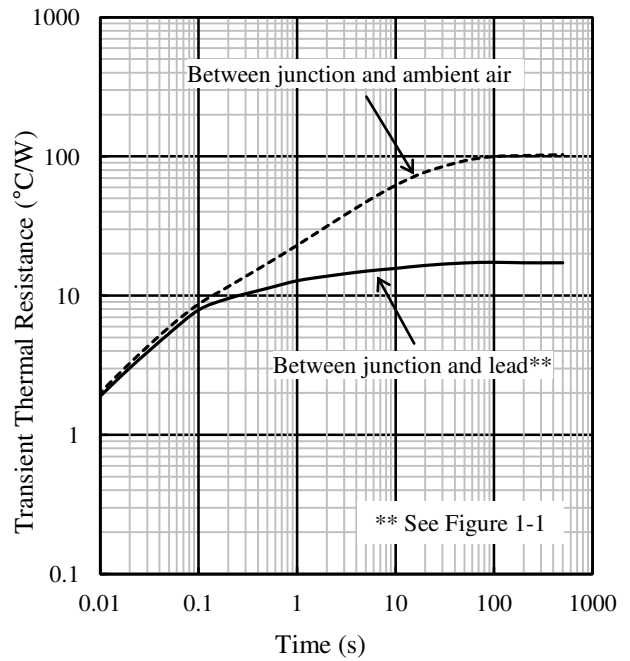
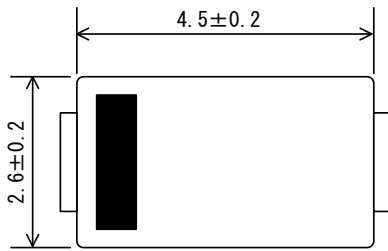


Figure 3-18 Typical transient thermal resistance

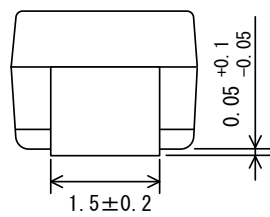
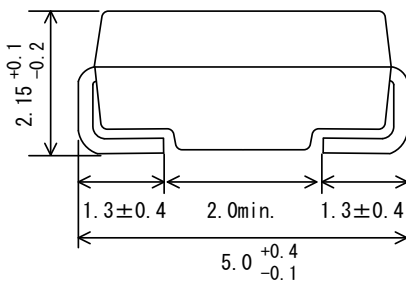
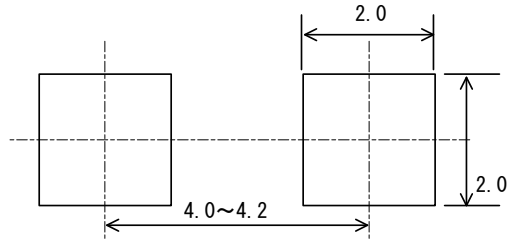
## SJPZ-N Series

### 4. External Dimensions

- SJP



Land Pattern Example



#### NOTES:

- Dimension is in millimeters.
- Lead treatment Pb-free. Device composition compliant with the RoHS directive.
- MSL : JEDEC LEVEL1

### 5. Marking Diagram

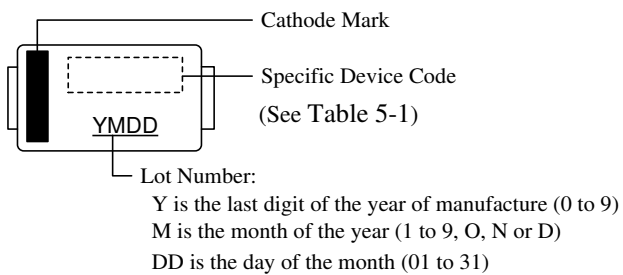


Table 5-1 Specific Device Code

| Specific Device Code | Products |
|----------------------|----------|
| ZN18                 | SJPZ-N18 |
| ZN27                 | SJPZ-N27 |
| ZN33                 | SJPZ-N33 |
| ZN40                 | SJPZ-N40 |

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